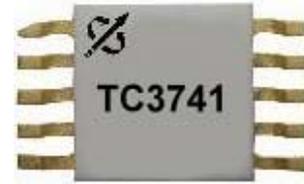


## 9.5 – 10.5 GHz 2W Single Bias MMIC

### FEATURES

- P<sub>1</sub> dB: 33 dBm
- Small Signal Gain: 11 dB
- Power Added Efficiency: 25 %
- IP3: 42 dBm
- Input/Output 50 Ω Match
- Bias condition: 1100 mA @ 10 V

### PHOTO ENLARGEMENT



### DESCRIPTION

The TC3741 is a 2-stage PHEMT Single Bias MMIC power amplifier. It is designed for use in low cost and high volume 9.5~10.5 GHz band applications. The MMIC is matched to 50Ω operation. It provides a typical gain of 11 dB and P1dB power of 33 dBm. Typical bias condition is 10V at 1100 mA. The MMIC is packaged in a copper based ceramic 10 pins power package. The copper based carrier of the package allows direct soldering of the device to the PCB.

### ELECTRICAL SPECIFICATIONS (T<sub>A</sub>=25 °C) @ 10GHz, V<sub>d</sub>=10V, I<sub>d</sub>=1100mA

Symbol	Conditions	MIN	TYP	MAX	UNIT
SSG	Small Signal Gain	10	11		dB
P <sub>1</sub> dB	Output Power at 1 dB Gain Compression	31.5	33		dBm
IP3	Third Order Intercept Point	40	42		dBm
VDD	Supply Voltage		10		Volt
IDD	Current Supply Without RF		1100		mA
η <sub>a</sub>	Power Added Efficiency		25		%

### Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min.	Max.	Units
V <sub>dd</sub>	Drain-Source Voltage		11	Volts
P <sub>in</sub>	RF Input Power		26	dBm
P <sub>t</sub>	Power Dissipation		13	W
T <sub>ch</sub>	Operating Channel Temperature		175	°C
T <sub>STG</sub>	Storage Temperature	-65	175	°C

#### Note:

1. This GaAs MMIC is susceptible to damage from Electrostatic Discharge. Proper precautions should be used when handling these devices.
2. Specifications subject to change without notice.

**Evaluation Board**

PCB Material: RO4003

ER = 3.38

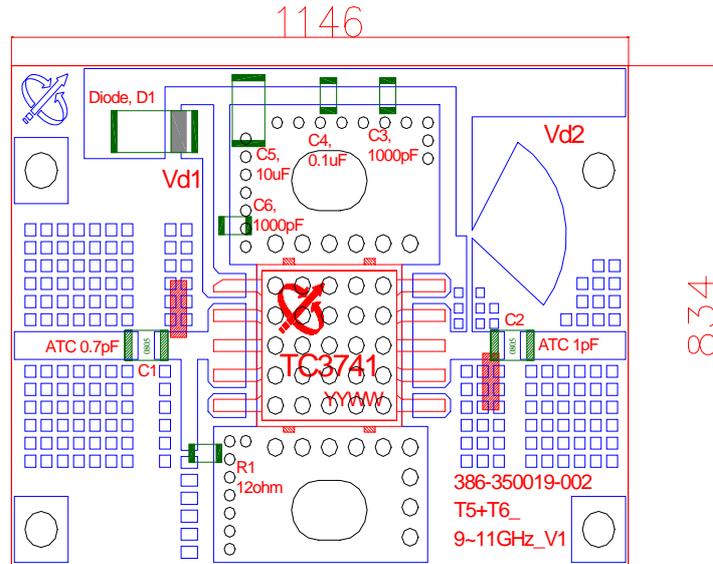
Thickness = 20 mil

Unit: mil

 \* DXF file of the PCB can be downloaded from our web-site at [www.transcominc.com.tw](http://www.transcominc.com.tw)

\* Application Notes:

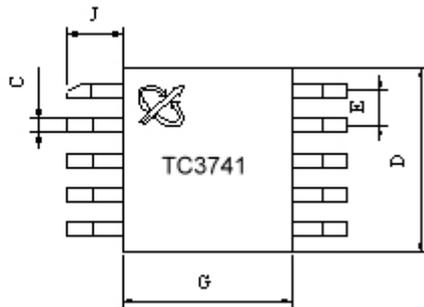
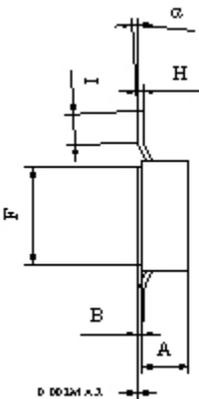
For better heat sinking and grounding, it's recommended to have the via holes beneath TC3741 filled with solder and have two screws installed on required heat sink plate besides TC3741 on the PCB area.


**Evaluation Board Parts List**

Qty	Part Type	Reference Designator	Description	Manufacturer	Part Number
1	Capacitor	C1	Chip CAP (0805) 0.7PF±0.1PF	ATC	600F0R7BT
1	Capacitor	C2	Chip CAP (0805) 1.0PF±0.1PF	ATC	600F1R0BT
2	Capacitor	C3, C6	Chip CAP (0603) 1000PF±10%	Murata	GRM39X7R102K50V
1	Capacitor	C4	Chip CAP (0603) 0.1µF±20%	Murata	GRM39Y5V104Z25V
1	Capacitor	C5	Chip CAP (1210) 10µF±20% or Chip CAP (1206) 10µF±20%	Murata	GRM42-6Y5V106Z25V or GRM31CF5E106ZA01L
1	Diode	D1	Diode, 400V, 1A (SOD-123)		
1	Resistor	R1	Chip resistor (0603) 12Ω±5%		

**Connection Diagram and PIN Descriptions**

Physical Dimensions (Unit:inchs)



DIMENSION	MINIMUM	NOMINAL	MAXIMUM
A	0.054	0.057	0.060
B	0.007	0.008	0.009
C	0.017	0.020	0.023
D	0.267	0.270	0.273
E	0.047	0.050	0.053
F	0.247	0.250	0.253
G	0.267	0.270	0.273
H	0.007	0.008	0.009
I	0.020	0.020	0.040
J	0.073	0.080	0.087
α	0°		7°